

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6326455

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YU WANG	06/16/2020
WEIMING GUAN	06/16/2020
ZHENXING LIANG	06/16/2020
RECEIVING PARTY DATA	
Name:	MEISHAN BOYA ADVANCED MATERIALS CO., LTD.
Street Address:	# 3, JUNLE ROAD, JINXIANG CHEMICAL INDUSTRIAL PARK, DONGPO DISTRICT
City:	MEISHAN
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17035741
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	19175283802
Email:	docketing@metis-ip.com
Correspondent Name:	YANGZHOU DU
Address Line 1:	PO BOX 423
Address Line 4:	MCLEAN, VIRGINIA 22101
ATTORNEY DOCKET NUMBER:	20664-0004US01
NAME OF SUBMITTER:	YANGZHOU DU
SIGNATURE:	/Yangzhou Du/
DATE SIGNED:	09/30/2020
Total Attachments: 3	
source=Assignment-20664-0004US00#page1.tif	
source=Assignment-20664-0004US00#page2.tif	
source=Assignment-20664-0004US00#page3.tif	

ASSIGNMENT

WHEREAS WE, the below named inventors (hereinafter referred to as Assignors) have made an invention entitled:

OPEN CZOCHRALSKI FURNACE FOR SINGLE CRYSTAL GROWTH

for which is a continuation of International Patent Application No. PCT/CN2019/101698 filed on August 21, 2019; and

WHEREAS, MEISHAN BOYA ADVANCED MATERIALS CO., LTD., a Chinese company whose address is # 3, Junie Road, Jinxiang Chemical Industrial Park, Dongpo District, Meishan, Sichuan, 620010, P.R. China, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to all applications for United States Letters Patent on this invention and the Letters Patent to be issued thereon;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, We, as Assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto Assignee, its lawful successors and assigns, our entire right, title, and interest in and to this invention, and these applications, and all national phase applications, divisions and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority in the United States and any other country on the basis of the above applications, and all applications for Letters Patent which may hereafter be filed for this invention in the United States and any other country and all Letters Patent which may be granted on this invention in the United States and any other country, and all extensions, renewals, and reissues thereof, and We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any other country whose duty is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that We have the full right to convey the interest assigned by this Assignment, and We have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all national phase, divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any other country, it being understood that any expense incident to the execution of such papers shall be borne by Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, We have hereunto set our hands.

Assignor

Name: WANG, Yu

Address: # 3, Junle Road, Jixiang Chemical Industrial Park

Dongpo District, Meishan

Sichuan, 620010, P.R. China

By: 

Date: 6/16/2020

Assignor

Name: GUAN, Weiming

Address: # 3, Junle Road, Jixiang Chemical Industrial Park

Dongpo District, Meishan

Sichuan, 620010, P.R. China

By: 

Date: 2020.6.16

Assignor

Name: LIANG, Zhenxing

Address: # 3, Junle Road, Jixiang Chemical Industrial Park

Dongpo District, Meishan

Sichuan, 620010, P.R. China

By: 

Date: 2020.6.16

Witness

Name: 刘西洋
Address: # 3, Junie Road, Jinxiang Chemical Industrial Park
Dongpo District, Meishan
Sichuan, 620010, P.R. China
By: 刘西洋
Date: 2020.6.6

Witness

Name: 张德强
Address: # 3, Junie Road, Jinxiang Chemical Industrial Park
Dongpo District, Meishan
Sichuan, 620010, P.R. China
By: 张德强
Date: 2020.6.6